

III-Nitride QD Lasers

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Abstract: III-Nitrides QD lasers are studied in detail. Two types of QD structures are considered, GaN/Al_xGa_{1-x}N/AlN and In_xGa_{1-x}N/In_{0.04}Ga_{0.96}N/GaN. Effects of: QD size; QD and WL composition; and doping are studied through the calculations of gain, threshold current, and intensity modulation bandwidth. It is shown that GaN QDs are less sensitive to size fluctuations. Bandwidth increases with doping and reducing QD size. The study covers approximately (300-600 nm) wavelength range.

I. INTRODUCTION

Semiconductor nitrides are very promising materials for their potential use in optoelectronic devices and high-temperature electronic devices. Until few years ago, the commonly quoted value for the optical bandgap of InN was 1.89 eV [1], but new measurements have shown evidence of a much smaller bandgap between 0.65 and 0.9 eV [2, 3]. The energy range of III-nitride (III-N) alloys from 6.2 eV (pure AlN) to 0.7 eV (pure InN) covers the spectral range from deep ultra violet (UV) to infrared (IR) at room temperature. These materials are thus, suitable for applications in UV detectors, Bragg reflectors, waveguides, and UV and visible light emitting diodes (LEDs). GaN-based LEDs and LDs have been achieved using thin films or QWs [1]. Development Laser diodes (LDs) of LDs with quantum dots (QDs), for example, is expected to result in a lower threshold current [4]. To access the advantages of QDs, the maximum size of QDs must be on the order of a few nanometers as a Prerequisite for utilization zero-dimensional confinement. With such small size, the practical applications are thus often associated with a large assembly of QDs rather than a single one. This implies that the size uniformity of the dot assembly is critical. Fluctuations in dot size produce an inhomogeneous broadening in quantized energy levels and may destroy the very properties expected from a single QD. Fabrication of a QD assembly with small and uniform size, high density, well-ordered placement, and defect-free materials today remains a serious challenge in any semiconductor system, especially when using III-N materials. The properties of III-N QDs are closely related to those of bulk materials that have been reviewed in many articles [5]. Although bulk GaN, AlN, and InN can all crystallize in wurtzite, zinc blende, and rock salt structures, in ambient conditions, the thermodynamically stable structure, however, is the wurtzitic phase. III-nitride QDs are commonly the strained systems. The lattice mismatch and its induced strain have a profound effect on the growth, structures, and properties of semiconductor QDs.

Strain induced self-organization of QDs is the common method to fabricate QDs [6]. A theoretical study of III-N QD lasers with the recent progress in these lasers is very important. This work addresses the properties of III-N lasers. The structures chosen are those specified in experiments. For example we use InGaN/In_{0.04}Ga_{0.96}N/GaN structures since some experiments refer to this structure as one of the most stable III-N structures. Beginning from energy level calculation, characteristics like gain and model gain are simulated, then threshold current is specified via rate equations (REs) represent structure layers: the separate confinement heterostructure (SCH) layer, wetting layer (WL), then ground and excited states (GS and ES) in the QD layer. Small signal analysis is applied to these REs to get intensity modulation response. The study covers a wide range of III-N wavelength spectrum. This is done by changing QD and WL composition. Different QD sizes are studied to see the effect of quantization on the above mentioned characteristics. During this study, a comparison between GaN and InGaN QDs is done. Importance is taken for some developments such as p-doping to demonstrate the superior of threshold current, and then modulation response, than the undoped structures.

II. GAIN OF III-N QDS

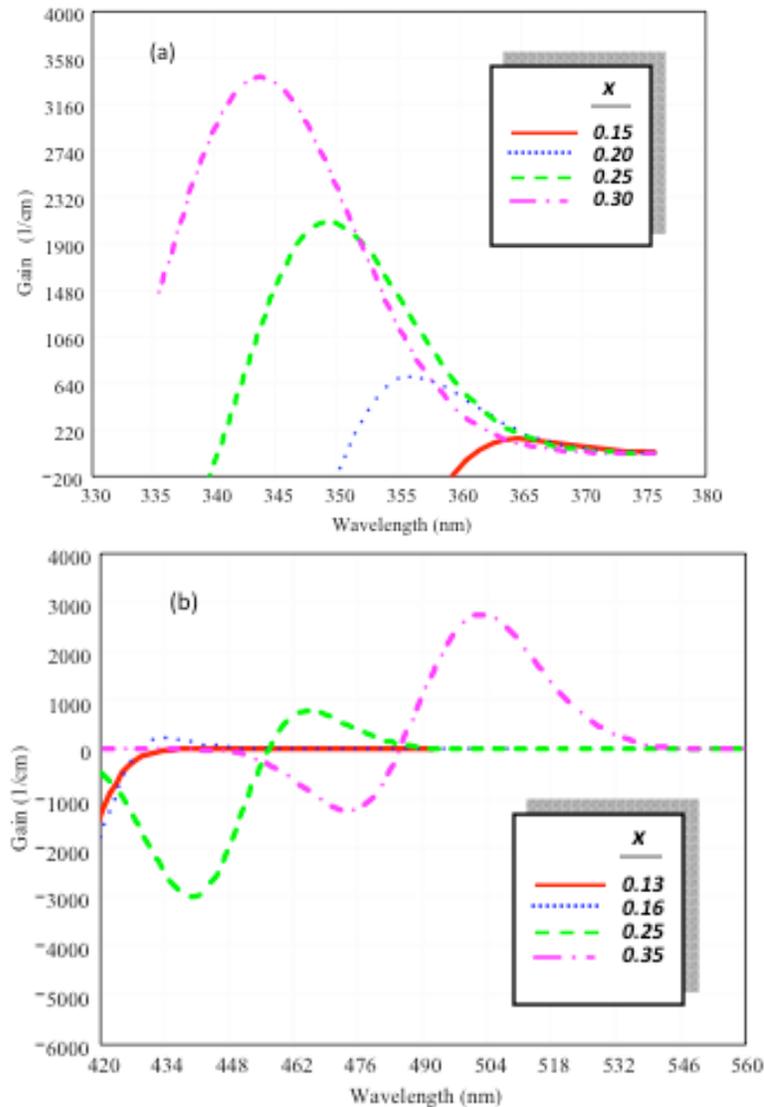
A. Model

Taking strain into account, a quantum disk model [7] is used to calculate the energy levels. Band lineup alignment is used to calculate the band edge among the QD, WL, and SCH. Two types of structures are studied. The first is GaN/Al_xGa_{1-x}N/AlN while the second is In_xGa_{1-x}N/In_{0.04}Ga_{0.96}N/GaN for different x-mole fraction values. These structures are specified thereafter in Table 1. The choice of these structures depends on the structures studied experimentally of QWs and QDs [5] and also to scan most of the spectrum gotten from the III-N structures. The size of the quantum disks studies are (the radius $\rho = 14$ nm and height $h = 2$ nm) if not referred to. Other QD sizes are also studied. The thickness of the wetting layer (WL) is 5nm, and that of the barrier is 33nm. The structures in Table 1 study either of these two interesting features. The first is changing WL (Al) composition and the second is changing the QD (In) composition. Thus we study along these calculations the effects of

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Table 1. The Differential Gain and Transparency Surface Carrier Density of the III-N QDs

QD Structure	a (cm ²)	N _{tr} (cm ⁻²)	QD Structure	a (cm ²)	N _{tr} (cm ⁻²)
GaN/Al _{0.15} Ga _{0.85} N/AlN	3.518E-19	2.403E+12	In _{0.13} Ga _{0.87} N/In _{0.04} Ga _{0.96} N/GaN	8.9E-21	3.546E+12
GaN/Al _{0.2} Ga _{0.8} N/AlN	1.311E-18	4.625E+9	In _{0.16} Ga _{0.84} N/In _{0.04} Ga _{0.96} N/GaN	5.96E-19	2.428E+12
GaN/Al _{0.25} Ga _{0.75} N/AlN	3.05E-18	1.547E+12	In _{0.25} Ga _{0.75} N/In _{0.04} Ga _{0.96} N/GaN	1.92E-18	2.702E+12
GaN/Al _{0.3} Ga _{0.7} N/AlN	8.022E-18	3.023E+12	In _{0.35} Ga _{0.65} N/In _{0.04} Ga _{0.96} N/GaN	3.49E-18	2.04E+12

**Fig. (1).** Gain spectra for: (a) GaN/Al_xGa_{1-x}N/AlN QD structures; (b) In_xGa_{1-x}N/In_{0.04}Ga_{0.96}N/GaN QD structures. The structures are with (0 acceptors/QD).

QD sizes, QD composition, WL composition, in addition to p-doping of these structures.

Assuming a homogenous strain [7], the energy levels of the structures are calculated. A behavior similar to that of tight binding calculations [2] is seen where the band structure exactly reflects the behavior expected for the local band structure in the region of the QD where the heavy-hole energy levels are reflected to higher energy. It is evidenced experimentally that InGaN/GaN QDs with 3-4nm lateral size

have an energy spacing of approximately 100meV [8]. In our work, In_{0.35}Ga_{0.65}N/In_{0.04}Ga_{0.96}N/GaN structure is studied at different QD radii (13, 12, 11, 10 and 9nm, respectively). The energy spacing between the 1st two conduction subbands in each size studied is increased with diminishing radius (30, 36, 41, 48 and 59meV, respectively). According to this, one can expect the same energy spacing as in [8] at smaller widths. For GaN/Al_{0.25}Ga_{0.75}N/AlN which studied at different QD radii, a less level spacing is shown.

Gain is calculated with an inhomogeneous broadening function works as a density of states of self-assembled QDs. A global quasi-Fermi levels including WL is assumed in the QD laser. This model is described well in [7]. The momentum matrix element for wurtzite crystals [1] is used in the gain calculations. Calculations are done at room temperature.

B. Gain Calculations

Fig. (1a) shows the calculated material gain spectra for GaN/Al_xGa_{1-x}N/AlN QD structure at surface electron densities per QD layer (n_{2D}) 10^{13} cm⁻². An increment in the gain and a blue shift in the wavelength (which is between 330-375 nm) are seen with increasing Al content. Fig. (1b) shows gain curves for In_xGa_{1-x}N/In_{0.04}Ga_{0.96}N/GaN QD structure where gain increases with In composition (x) in the dot while emitted wavelength shows a red shift. It covers the range 430-540 nm. Photoluminescence emission from InGaN/GaN QDs measured in [8] covers part of these wavelengths. Comparing curves in Figs. (1a and 1b), shows that GaN QDs

have higher gain. The calculated differential gain (a) and surface transparency carrier density (N_{tr}) values are listed in Table 1.

C. p-Doping Effect

Fig. (2a) shows the calculated material gain spectra for undoped GaN/Al_{0.3}Ga_{0.7}N/AlN QD structure (dashed curves) at surface electron densities per QD layer ($n_{2D} = 8.3 \times 10^{12}$, 8.6×10^{12} , 9×10^{12} and 10^{13} cm⁻²). The peak wavelength (λ_p) is blue shifted with increasing n_{2D} . To get (approximately) the same peak gain value for p-doped structures (solid curves) we use ($n_{2D} = 3.7 \times 10^{12}$, 5.2×10^{12} , 6.3×10^{12} and 7.5×10^{12} cm⁻²). The p-doped QD laser requires less surface electron density to achieve the same peak gain than the undoped one due to the hole supply from the p-type doping. Fig. (2b) shows gain curves for doped In_{0.25}Ga_{0.75}N/In_{0.04}Ga_{0.96}N/GaN QD structure (solid curves) at surface

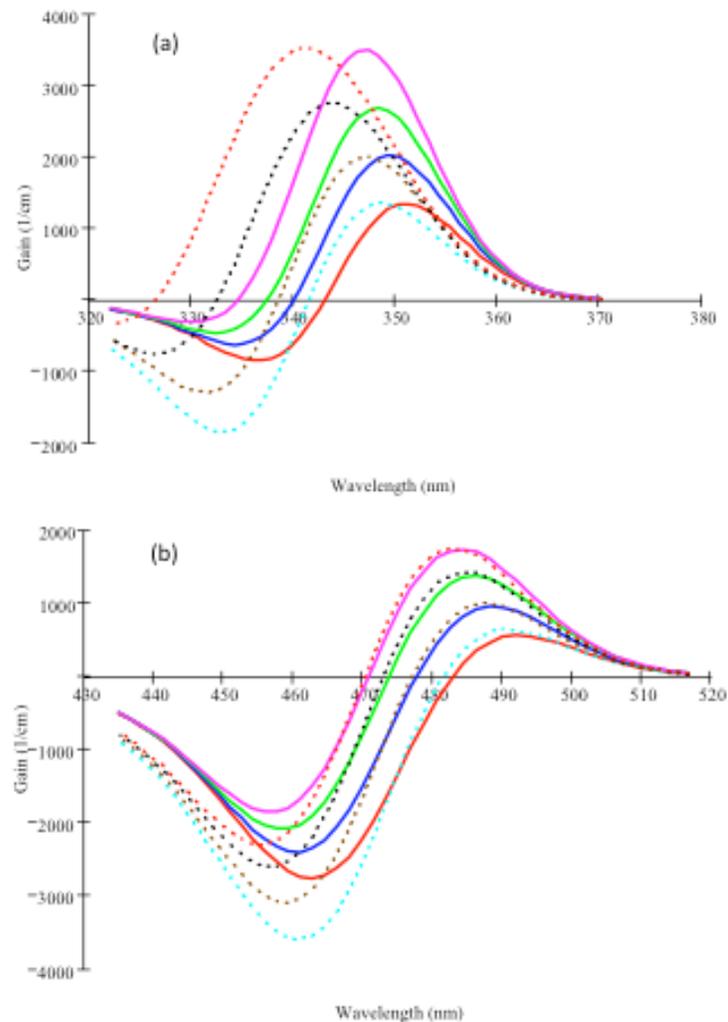


Fig. (2). (a) Calculated material gain spectra of GaN/Al_{0.3}Ga_{0.7}N/AlN QD laser for undoped structure (dashed curves) with surface electron densities per QD layer $n_{2D} = 8.3 \times 10^{12}$, 8.6×10^{12} , 9×10^{12} and 10×10^{12} cm⁻². Doped structure (solid curves) with surface electron densities per QD layer $n_{2D} = 3.7 \times 10^{12}$, 5.2×10^{12} , 6.3×10^{12} and 7.5×10^{12} cm⁻². (b) An undoped In_{0.25}Ga_{0.75}N/In_{0.04}Ga_{0.96}N/GaN QD laser (dashed curves) with $n_{2D} = 8 \times 10^{12}$, 10.2×10^{12} , 12.9×10^{12} and 14.9×10^{12} cm⁻² compared with the p-doped ones (solid curves) with $n_{2D} = 4 \times 10^{12}$, 6×10^{12} , 8×10^{12} and 10^{13} cm⁻² are used for the p-doped QD laser.

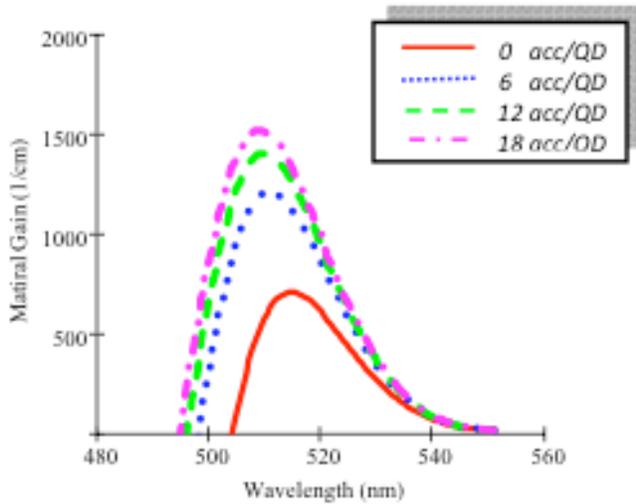


Fig. (3). Comparison of gain spectra for $\text{In}_{0.35}\text{Ga}_{0.65}\text{N}/\text{In}_{0.04}\text{Ga}_{0.96}\text{N}/\text{GaN}$ QD laser at $n_{2D} = 6 \times 10^{12} \text{ cm}^{-2}$ injection surface carrier density and different acc/QD levels.

electron densities per QD layer ($n_{2D} = 4 \times 10^{12}, 6 \times 10^{12}, 8 \times 10^{12}$ and 10^{13} cm^{-2}) and undoped (dashed curves) ones at ($n_{2D} = 8 \times 10^{12}, 10.2 \times 10^{12}, 12.9 \times 10^{12}$ and $14.9 \times 10^{12} \text{ cm}^{-2}$). Comparing these curves with those in Fig. (2a) shows that we need more electron density to get the same peak for $\text{In}_{0.25}\text{Ga}_{0.75}\text{N}/\text{In}_{0.04}\text{Ga}_{0.96}\text{N}/\text{GaN}$ QD structure while the $\text{GaN}/\text{AlGa}/\text{AlN}$ p-doped curves shows an obvious red shift not seen in InGaN . III-N QDs needs higher carrier density in comparison with GaAs based QDs [7]; this of course because of a heavier effective masses than the conventional zinc blende crystals. The range of carriers used here ($\sim 10^{12}$ - 10^{13} cm^{-2}) same as that used by [9] to attain gain in GaN QWs. Let us check the shift in the peak gain wavelength (λ_p) with surface carrier density. In the structures studied in Figs. (2a and 2b), for both doped and undoped ones, the increment in λ_p with surface carrier density is not more than (0.67-5 nm). This means a low dependence of λ_p on carrier density. Fig. (3) compares the gain curves at the same surface carrier density (n_{2D}) for different doping density (acceptors/QD, acc/QD). At a lower doping density (0, 6) gain increases faster, then after (12 acc/QD) the increment becomes small with further doping.

D. Homogenous and Inhomogeneous Broadening Effect

QDs known to have a small size, the practical applications are associated with large assembly of QDs. This implies that the size uniformity of the dot assembly is critical. Fluctuations of dot size produce an inhomogeneous broadening in quantized energy levels and may destroy the very properties expected from a single QD. Thus it is important to study the effect of Inhomogeneous broadening of QDs on gain. Fig. (4a) gives the gain variation with the evolution of broadening from homogeneous to inhomogeneous with the assumption of constant temperature. While it maximizes by ~ 3.5 times for GaN QDs, it maximizes by ~ 7 times for In-

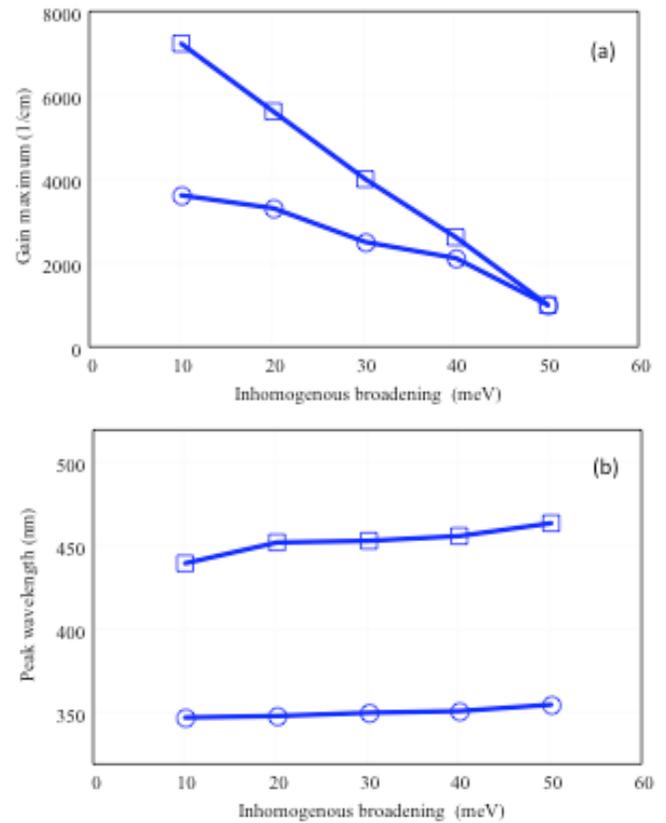


Fig. (4). Inhomogeneous broadening effect for $\text{GaN}/\text{Al}_{0.2}\text{Ga}_{0.8}\text{N}/\text{AlN}$ (circles) and structures $\text{In}_{0.35}\text{Ga}_{0.65}\text{N}/\text{In}_{0.04}\text{Ga}_{0.96}\text{N}/\text{GaN}$ (squares) on (a) peak gain, and (b) peak wavelength.

GaN QDs. Fig. (4b) shows λ_p variation with broadening. While InGaN changes by $\sim 40 \text{ nm}$, it is $\sim 15 \text{ nm}$ for GaN QDs. From this figure one can see that GaN QDs are less sensitive to size fluctuations than InGaN QDs.

E. Q Disk Size Effects

To study the quantum size effects on the disk, different shapes are studied by changing their radius and height. Then, gain is calculated. Fig. (5) shows maximum gain (g_{max}) and λ_p variation with the height of the disk (h) for $\text{GaN}/\text{Al}_{0.25}\text{Ga}_{0.75}\text{N}/\text{AlN}$ structure at radius ($\rho = 14 \text{ nm}$), Fig. (5a), and then with radius at height ($h = 2 \text{ nm}$), Fig. (5b). It is shown that g_{max} increases with reducing size (ρ or h). Fig. (6) studies size effects on $\text{In}_{0.35}\text{Ga}_{0.65}\text{N}/\text{In}_{0.04}\text{Ga}_{0.96}\text{N}/\text{GaN}$. Both Figs. (5 and 6) are done at ($n_{2D} = 8 \times 10^{12} \text{ cm}^{-2}$) and (6 acc/QD). In all of these figures it is shown that g_{max} increases with reducing size. An interesting phenomenon is the g_{max} increment in $\text{GaN}/\text{Al}_{0.25}\text{Ga}_{0.75}\text{N}$ QDs when one scales the disk height from 4 to 3 nm which appear in Fig. (5a). The gain scales by (18) times increment while all the other cases studied are changes by (1-4) times. This can be explained when one check the number of energy levels. When $h = 4 \text{ nm}$ we have (12) levels for CB and (24) levels for VB. When $h = 3 \text{ nm}$ we have (12) levels for CB and (16) levels for VB. Thus, the number of VB levels is reduced. However, a nar-

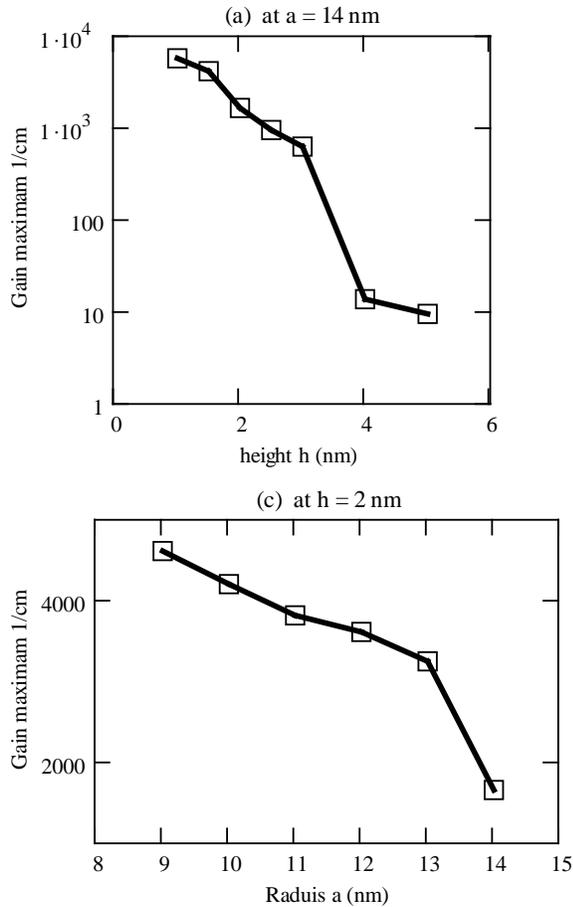


Fig. (5). Gain maximum g_{max} as a function of disk height (a) and disk radius (b) for GaN/Al_{0.25}Ga_{0.75}N/AlN QD structure. Calculations are done at (6 acc/QD).

row size has a larger separation of subbands, resulting in sharper gain spectra than those of a wider size.

III. RATE EQUATIONS MODEL

The occupation probabilities of QD lasers are modeled in the rate equations (REs) by several authors, for example [10] where the QD is assumed to have only two confined energy states, the ground state (GS) and the excited state (ES). GS have a degeneracy equal 2 while ES has degeneracy equal 4 due to the QD symmetry in the growth plane [7]. We add a RE for the separate confinement heterostructure (SCH) layer to the model, taking into account the Pauli-blocking in the WL, to become have a model includes REs for SCH, WL, GS and ES of QD in addition to the photons Equation. We use this model to calculate threshold current (and then modulation response) for QD structures studied. According to these assumptions in our model, the carriers are injected in the SCH barrier with rate (I/q) , relax in the WL state with a rate $(1/\tau_{c,sch})$ (or escape back in the barrier with a rate $1/\tau_{e,wl}$). From the WL they can be captured in the dot. Therefore, the WL state acts as a common reservoir from which the carriers are captured in the ES with rate

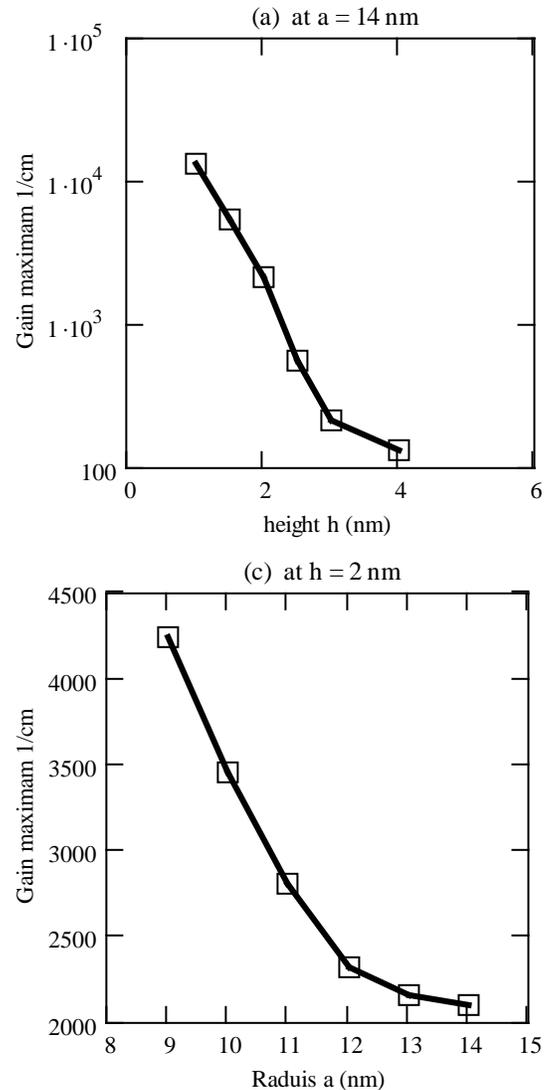


Fig. (6). Gain maximum g_{max} as a function of disk height (a) and disk radius (b) for In_{0.35}Ga_{0.65}N/In_{0.04}Ga_{0.96}N/GaN QD structure. Calculations are done at (6 acc/QD).

$(1/\tau_{c,wl})$, and from the ES to the GS with rate $(1/\tau_{c,ES})$. The carriers escape also from the GS back in the ES with rate $(1/\tau_{e,GS})$ or from the ES back in the WL with rate $(1/\tau_{e,ES})$. Carriers can also recombine with radiative (and nonradiative) processes from the SCH, the WL and the various confined states with rates $(1/\tau_{sr})$, $(1/\tau_{wr})$ and $(1/\tau_r)$, respectively. We assume that the stimulated emission can take place only due to recombination between the electron and hole in the GS [10]. The rate of photons emitted out of the cavity is (S_p/τ_p) , with τ_p the corresponding photon lifetime of the mode and S_p is the photon occupation probability. The resulting REs system for the carrier occupation probability is as follows:

$$\frac{df_{sch}}{dt} = \frac{I}{q} - \frac{f_{sch}(1-f_{wl})}{\tau_{c,sch}} + \frac{f_{wl}}{\tau_{e,wl}} - \frac{f_{sch}}{\tau_{sr}} \quad (1)$$

$$\frac{df_{wl}}{dt} = \left(\frac{f_{sch}}{\tau_{c,sch}} + \frac{4f_{ES}}{\tau_{e,ES}} \right) (1-f_{wl}) - \frac{f_{wl}}{\tau_{e,wl}} - \frac{f_{wl}}{\tau_{c,wl}} (1-f_{ES}) - \frac{f_{wl}}{\tau_{wr}} \quad (2)$$

$$\frac{df_{ES}}{dt} = \left(\frac{f_{wl}}{4\tau_{c,wl}} + \frac{f_{GS}}{2\tau_{e,GS}} \right) (1-f_{ES}) - \frac{f_{ES}}{\tau_{e,ES}} (1-f_{wl}) - \frac{f_{ES}}{\tau_{c,ES}} (1-f_{GS}) - \frac{f_{ES}}{\tau_r} \quad (3)$$

$$\frac{df_{GS}}{dt} = \frac{2f_{ES}}{\tau_{c,ES}} (1-f_{GS}) - \frac{f_{GS}}{\tau_{e,GS}} (1-f_{ES}) - \frac{f_{GS}}{\tau_r} - v_g \Gamma g_{GS} S_p \quad (4)$$

$$\frac{dS_p}{dt} = v_g \Gamma g_{GS} S_p - \frac{S_p}{\tau_p} + \beta \frac{2f_{GS}}{\tau_r} \quad (5)$$

The occupation probabilities for the GS and ES are defined as $f_{GS} = n_{GS}/2N_D$ and $f_{ES} = n_{ES}/4N_D$, where $n_{GS}(n_{ES})$ is the number of electron-hole (e-h) pairs in the GS(ES), N_D is the total number of QDs, g_{GS} is the GS gain while the SCH and WL populations and the photon occupation are described by the normalized terms: $f_{sch} = n_{sch}/N_D$, $f_{wl} = n_{wl}/N_D$, and $S_p = n_p/N_D$, respectively. Note that n_p is the photon number. I is the injection current, q is the electron charge, and Γ is the confinement factor. In Eq. (5), the last term on the right-hand side ($\beta 2f_{GS}/\tau_r$) represents the rate of photons emitted by spontaneous emission coupled into the lasing mode. The size inhomogeneity of the dots is also included through the expression of the capture and escape times; in Eqs. (1-4) these time constants are given by Eq. (6) [11] at the bottom of the page.

$\tau_{c,sch}$, $\tau_{c,wl}$, and $\tau_{c,ES}$ are the average capture times from the SCH to the WL, from the WL to the ES and from the ES to the GS, respectively, with the hypothesis that the final state is empty. The emission times $\tau_{e,GS}$, and $\tau_{e,ES}$

are the escape from the GS back in the ES and the escape from the ES back in the WL. τ_o^{-1} is the relaxation rate when the level state is unoccupied, i.e., $f = 0$. As f approaches 1 the relaxation rate decreases, resulting in the occupation of the upper level. Furthermore, at room temperature and before reaching stimulated emission the system must converge to a quasi-thermal equilibrium characterized by a Fermi distribution of the carriers in all the states. To ensure this convergence the carrier escape times are related to the carrier capture times as in Eq. (7) [11], which appears in bottom of this page.

With S_1 and S_2 are the degeneracy of the GS and ES levels, E_{GS} , E_{ES} and E_{wl} are the energies of the GS, ES and the first WL level, respectively. In the above expressions N_d is the density of QDs per unit area, N_w is the number of QD layers and H_b is the total thickness of the SCH. $\rho_{wl,eff}$ (ρ_{sch}) is the density of states per unit area (volume) in the WL (SCH). They are given by Eq. (8) [11] which appears at the bottom of the page.

$$\tau_{c,sch}^{-1} = (1-f_{wl})\tau_{c0,sch}^{-1}, \tau_{c,wl}^{-1} = (1-f_{ES})\tau_{c0,wl}^{-1}, \tau_{c,ES}^{-1} = (1-f_{GS})\tau_{c0,ES}^{-1}, \quad (6)$$

$$\tau_{e,GS}^{-1} = (1-f_{ES})\tau_{e0,GS}^{-1}, \tau_{e,ES}^{-1} = (1-f_{wl})\tau_{e0,ES}^{-1}$$

$$\tau_{e,GS} = \tau_{c,ES} \frac{S_1}{S_2} e^{\frac{E_{ES}-E_{GS}}{K_B T}}, \tau_{e,ES} = \left(\frac{N_d S_1}{\rho_{wl,eff}} \right) \tau_{c,wl} e^{\frac{E_{wl}-E_{ES}}{K_B T}}, \quad (7)$$

$$\tau_{e,wl} = \left(\frac{\rho_{wl,eff} N_w}{\rho_{sch} H_b} \right) \tau_{c,sch} e^{\frac{\Delta E_{wl,wl}}{K_B T}}$$

$$\rho_{wl,eff} = \frac{m_{ewl} K_B T}{\pi \hbar^2}, \quad \rho_{sch} = 2 \left(\frac{2m_{esch} \pi K_B T}{\hbar^2} \right)^{3/2} \quad (8)$$

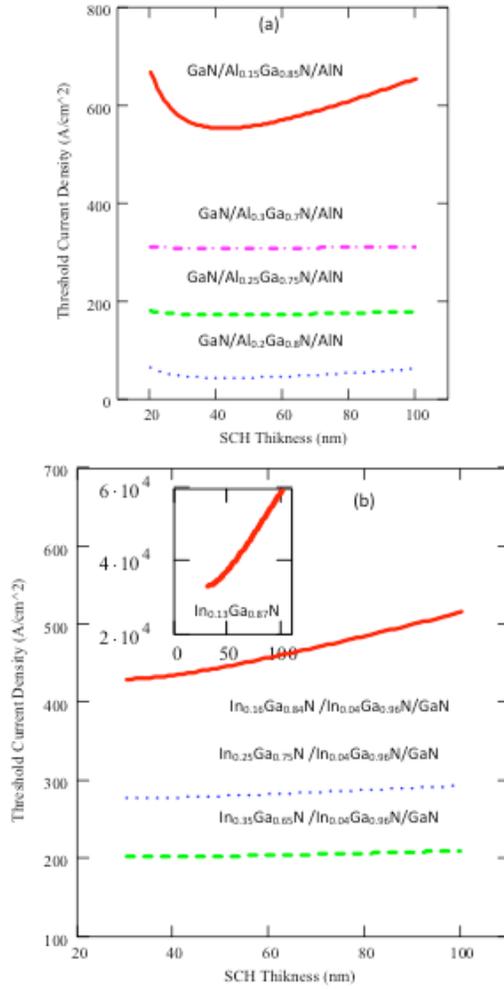


Fig. (7). (a) and (b) The threshold current density J_{th} as a function of the SCH thickness L_{sch} .

REs (1)-(4) are solved analytically, at steady state by setting all time derivatives to zero, to get analytical expression for the threshold current density. The small-signal solution [12, 13] for these REs is done thereafter to get a relation for the intensity modulation response.

IV. THRESHOLD CURRENT

Table 2 reports the parameters of the QD material and the laser cavity under investigation. The QD material parameters are corresponds to those of an InGaN/InGaN/GaN and

Table 2. Parameters of the QD Material and Laser [10]

QD Material Parameters	Laser Parameters
Diffusion in SCH, $\tau_{c,sch} = 1$ ps	Active region length, $L = 900$ nm
SCH recombination, $\tau_{sr} = 4.5$ ns	Active region width, $W = 0.1$ μ m
WL recombination, $\tau_{wr} = 3$ ns	Number of QD layers, $N_w = 10$
Capture from WL to ES, $\tau_{c,wl} = 1$ ps	QD density per unit area, $N_d = 5 \times 10^{12}$ cm ⁻²
Capture from ES to GS, $\tau_{c,es} = 7$ ps	Internal loss, $\alpha_{int} = 3$ cm ⁻¹
ES and GS recombination, $\tau_r = 2.8$ ns	Spontaneous emission factor, $\beta = 10^{-4}$
Inhomogeneous broadening (Gaussian FWHM) 50 meV	

GaN/AlGaIn N QD material systems. Dependence of threshold current density (J_{th}) on the thickness of SCH layer (L_{sch}) is shown in Fig. (7a and 7b). J_{th} is shown to have a minimum at some value of L_{sch} . GaN structures studied in Fig. (7a) depend on changing WL composition. J_{th} accounts from REs model depends on occupation probabilities of WL and SCH. III-N structures have high threshold current. This high threshold current for N-containing laser is also measured experimentally for InGaAsN QD laser (577 A/cm²) [14], which is in the same range of our calculations seen in Figs. (7a and 7b). While in Fig. (7b) J_{th} decrease with increasing in composition, in Fig. (7a) the picture is not in this simplest arrangement. J_{th} decreases first with Al composition then it increases. Table 1 gives an explanation of this picture where the transparency surface carrier density have the same arrangement appear in Fig. (7a).

A. p-Doping Effect

Fig. (8a and 8b) shows J_{th} versus SCH thickness for GaN/Al_{0.15}Ga_{0.85}N/AlN and In_{0.16}Ga_{0.84}N/In_{0.04}Ga_{0.96}N/GaN structures at different doping densities. The interesting feature can be seen is the J_{th} reduction with doping. The optimum values are stated in Table 3. It is shown that increasing doping from 0 to 18 acceptors reduces J_{th} by ~ 7 times for In_{0.16}Ga_{0.84}N and 3 times for GaN QDs and the minimum L_{sch} reduces by 4nm. One must note that we chose these two structures with higher threshold and the GaN structure chosen have threshold higher than that of InGaN chosen as seen in Fig. (7). The modal gain spectra for GaN QDs are shown in Fig. (9a) while In_{0.35}Ga_{0.65}N spectra are shown in Fig. (9b). Factors are taken from Table 2. The optical confinement factor (Γ) is calculated for these structures as (0.026) for GaN and (0.030) for InGaN QDs. In Fig. (9a) the maximum modal gain of the GaN/Al_{0.3}Ga_{0.7}N/AlN QD laser is 110 cm⁻¹ (11 cm⁻¹ per QD layer) at the wavelength of 349 nm. In Fig. (9b) the peak modal gain is 14 cm⁻¹ at the lasing wavelength of 509 nm for In_{0.35}Ga_{0.65}N/In_{0.04}Ga_{0.96}N/GaN QD laser. These high maximum modal gain values are achievable due to p-type doping with ten layers of QDs. The higher Γ value for InGaN contributes in its lower J_{th} and higher model gain. A modal gain of 20 cm⁻¹ is measured for

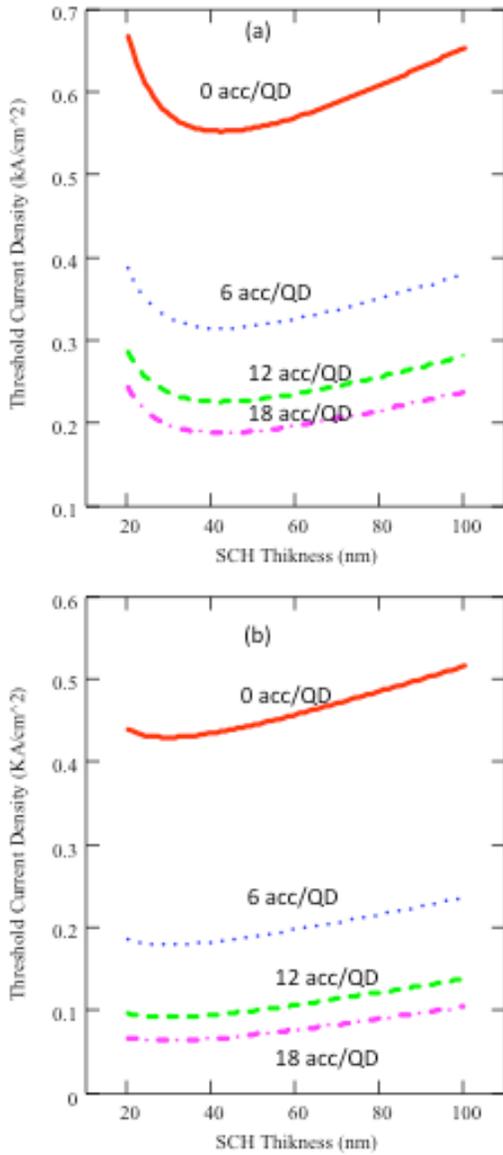


Fig. (8). Threshold current density as function thickness of SCH for (a) doped GaN/Al_{0.15}Ga_{0.85}N/AlN QD structure (b) doped In_{0.16}Ga_{0.84}N /In_{0.04}Ga_{0.96}N/GaN QD structure.

InAs/InGaAs [7] at $\lambda_p=1288\text{nm}$, and calculated to be 28 cm^{-1} for InAs/GaAs at $\lambda_p=0.96\text{eV}$ [11]. So, compared with these results it is shown to be acceptable as one appreciates GaN to GaAs materials.

Table 3. Effect of Doping on the Threshold Current Density

GaN/Al _{0.15} Ga _{0.85} N/AlN			In _{0.16} Ga _{0.84} N /In _{0.04} Ga _{0.96} N/GaN		
Acc/QD	J_{th} (KA/cm ²)	L_{SCH} (nm)	Acc/QD	J_{th} (KA/cm ²)	L_{SCH} (nm)
0	0.552	40	0	0.429	29
6	0.314	40	6	0.179	28
12	0.226	38	12	0.091	28
18	0.188	40	18	0.063	25

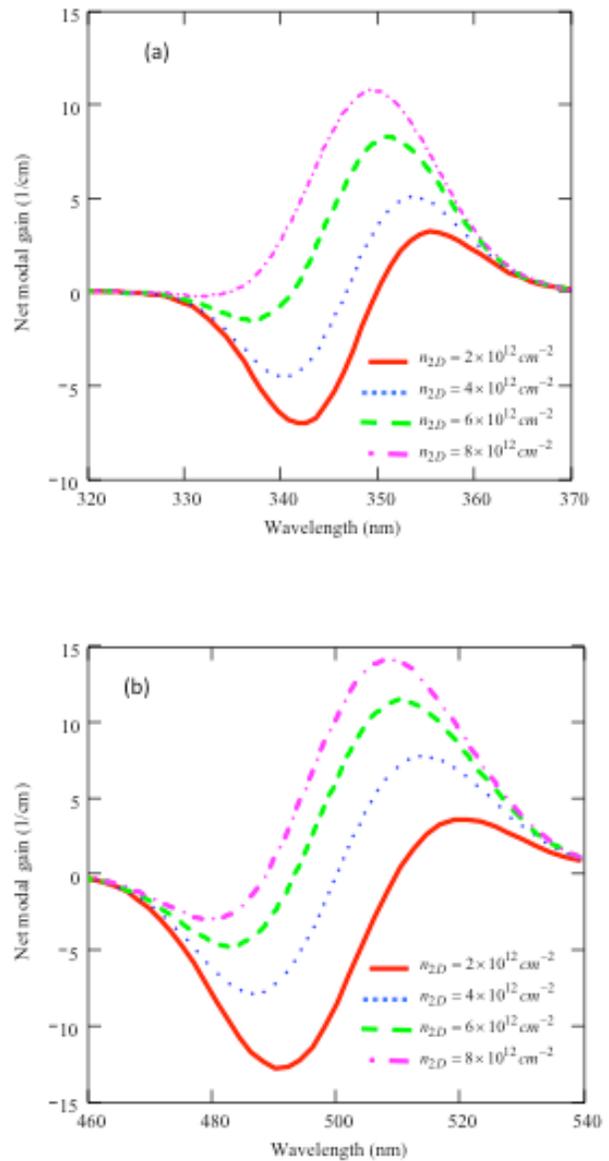


Fig. (9). Calculated net modal gain spectra of a p-doped (a) GaN/Al_{0.3}Ga_{0.7}N/AlN QD laser (b) In_{0.35}Ga_{0.65}N/In_{0.04}Ga_{0.96}N/GaN QD laser, at various surface electron densities per QD layer.

V. INTENSITY MODULATION RESPONSE

Applying small signal response on the REs model, intensity modulation (IM) for III-N QDs is studied. Quantum size

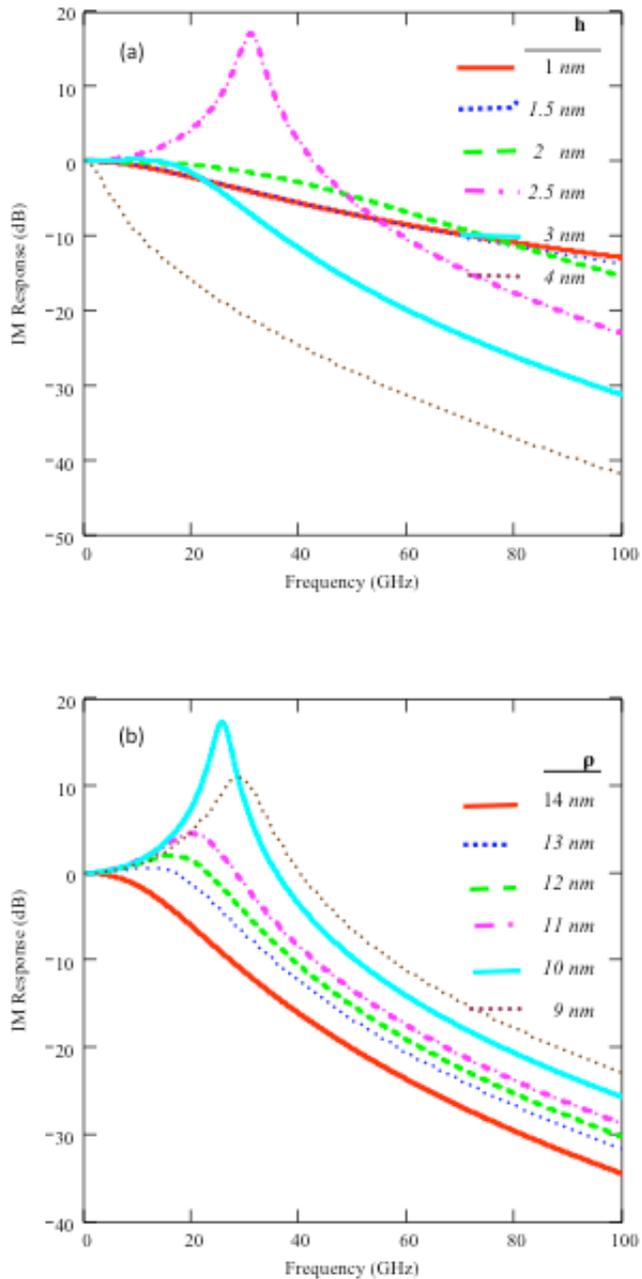


Fig. (10). IM response at various indicated sizes for (a) disk radius at $\rho = 14 \text{ nm}$ and (b) disk height at $h = 2 \text{ nm}$ for GaN/Al_{0.25}Ga_{0.75}N/AlN QD structure. Calculations are done at (6 acc/QD).

effects on IM response are shown in Figs. (10a and 10b) for GaN/Al_{0.25}Ga_{0.75}N/AlN. As seen from Fig. (10a), the bandwidth (BW) increases with height until $h = 2.5 \text{ nm}$ then damping increases, while it increases with longer radius as in Fig. (10b). A similar behavior is seen for InGaN structure (not seen here). Fig. (11a) shows the dependence of the IM response on the capture time from WL to excited state ($\tau_{c,sch}$). It shows that it increases BW and f_R then, they are reduced for longer $\tau_{c,sch}$ times (3ns). Fig. (11b)

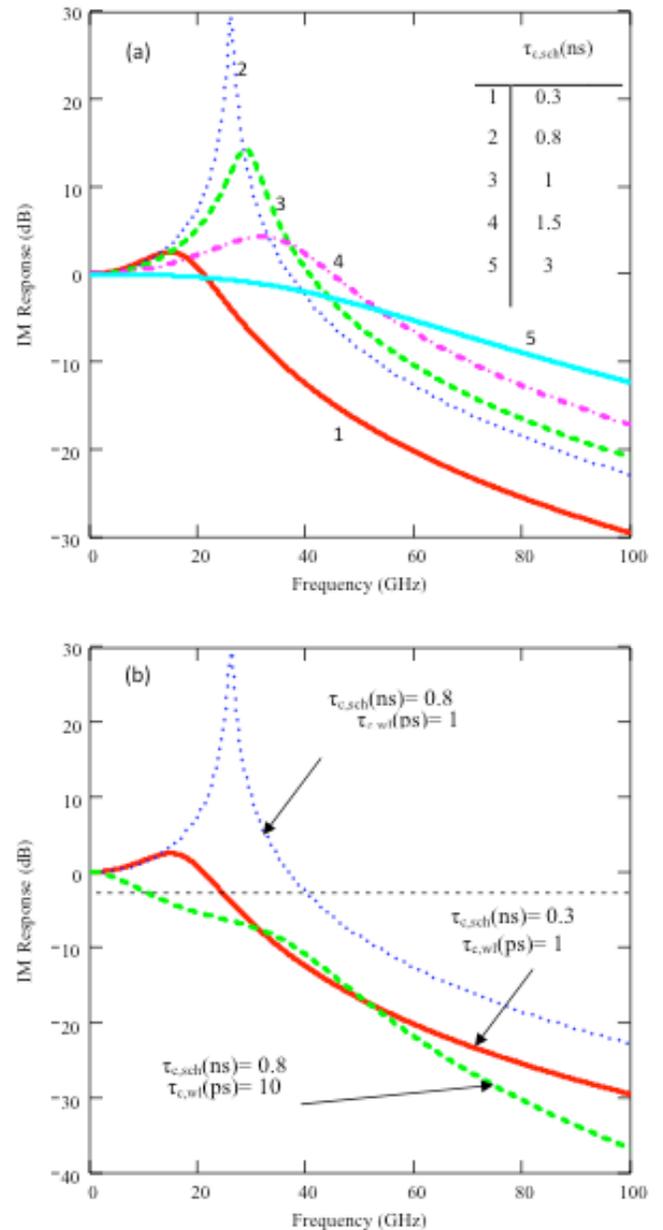


Fig. (11). (a) Dependence of the intensity modulation response on $\tau_{c,sch}$ of GaN/Al_{0.2}Ga_{0.8}N/AlN QD laser. (b) Intensity modulation response for different f_R and $\tau_{c,wl}$. Both plots with 1.5 mW output power.

examine the same dependence in (a) for various values of capture time $\tau_{c,wl}$. Both plots taken at output power $P_{out} = 1.5 \text{ mW}$. Fig. (11b) shows the importance of $\tau_{c,wl}$ where a longer capture time of WL shown to give BW smaller than f_R where a premature roll off in the IM response is shown. In Fig. (12) we plot the IM response at different levels of p-doping for (a) GaN/Al_{0.15}Ga_{0.85}N/AlN and (b) In_{0.16}Ga_{0.84}N/In_{0.04}Ga_{0.96}N/GaN QD lasers, respectively. It is shown that the bandwidth increases with doping. But, after

Table 4. Summary of Small Signal Modulation Devices Performance

Doping (Acc/QD)	BW (GHz)	
	GaN/Al _{0.15} Ga _{0.85} N/AlN	In _{0.16} Ga _{0.84} N/In _{0.04} Ga _{0.96} N/GaN
0	40.6	30.8
6	42.9	36.8
12	43.7	39.2
18	44	39.6

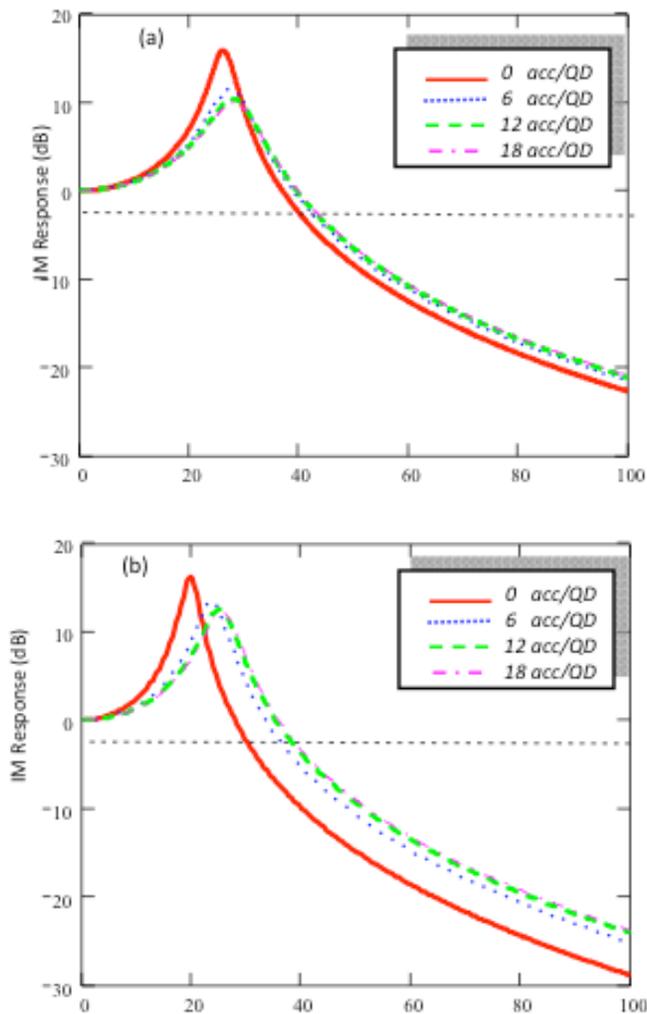


Fig. (12). Dependence of the intensity modulation response on p-doping effect of (a) GaN/Al_{0.15}Ga_{0.85}N/AlN QD laser and (b) In_{0.16}Ga_{0.84}N/In_{0.04}Ga_{0.96}N/GaN QD laser.

(12 acc/QD) the increment is not of considerable importance. So it is important to make doping until this level, in applications require high speed, when these structures are used. Table 4 summarizes bandwidth characteristics for these structures. Where the bandwidth increase from 40 to 44 GHz for GaN QDs and from 30 to 39 GHz for InGaN QDs. While Ledentsov *et al.* [4] measured 59GHz bandwidth for GaAs QD laser emitting at 960nm, Kuntz *et al.* [15] measured

1.8GHz bandwidth increase for InGaAs QD laser emitting at 1.3 μ m with $5 \times 10^{17} \text{ cm}^{-3}$ p-doping which is the same range of increment in our structures.

VI. CONCLUSIONS

This work studies the performance of III-N QD lasers. Two types of structures are studied: GaN/Al_xGa_{1-x}N/AlN and In_xGa_{1-x}N/ In_{0.04}Ga_{0.96}N /GaN. Gain is studied for these structures where GaN QDs shown to be stands against inhomogeneous broadening than InGaN QDs. Modal gain shown to be higher for InGaN due to higher confinement. Threshold current shown to be reduced with doping while the intensity modulation bandwidth shown to increase with it. For both threshold current and bandwidth it is shown that doping is active until some value then the increment is not so important. The study covers (300-600 nm) wavelength ranges.

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